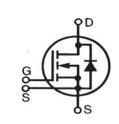
IXTN200N10L2

Linear L2[™] Power **MOSFET w/ Extended FBSOA**

N-Channel Enhancement Mode **Guaranteed FBSOA** Avalanche Rated



V

V

V

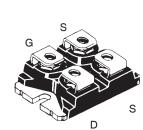
V

А

А

V _{DSS}	=	100V
D ₂₅	=	178A
R _{DS(on)}	\leq	11m Ω

miniBLOC, SOT-227 E153432



G = Gate D = Drain S = Source

Either Source Terminal S can be used as the Source Terminal or the Kelvin Source (Gate Return) Terminal.

Features

- MiniBLOC with Aluminium Nitride Isolation
- Designed for Linear Operation
- International Standard Package
- Guaranteed FBSOA at 75°C
- Avalanche Rated
- Molding Epoxy Meets UL94 V-0 Flammability Classification

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- Programmable Loads
- Current Regulators
- DC-DC Converters
- Battery Chargers
- DC Choppers
- Temperature and Lighting Controls

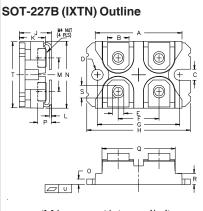
Symbol	Test Conditions	Maximum Ratings
V _{DSS}	$T_{J} = 25^{\circ}C$ to $150^{\circ}C$	100
V_{DGR}	$T_{J} = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	100
V _{GSS}	Continuous	±20
V_{gSM}	Transient	±30
I	$T_c = 25^{\circ}C$	178
I _{DM}	$T_{_{C}}$ = 25°C, Pulse Width Limited by $T_{_{JM}}$	500

I _A	$T_c = 25^{\circ}C$		100	А
E _{AS}	$T_{c} = 25^{\circ}C$		5	J
P _D	$T_c = 25^{\circ}C$		830	W
T,			-55 +150	C°
T _{JM}			150	°C
T _{stg}			-55 +150	O°
T,	1.6mm (0.062 in.) fro	om Case for 10s	300	°C
	Plastic Body for 10s		260	C°
VISOL	50/60 Hz, RMS	t = 1 Minute	2500	V~
.001	$I_{ISOL} \le 1 m A$	t = 1 Second	3000	V~
M _d	Mounting Torque		1.5/13	Nm/lb.in.
-	Terminal Connection	Torque	1.3/11.5	Nm/lb.in.
Weight			30	g

Symbol $(T_J = 25^{\circ}C,$	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.
BV _{DSS}	$V_{gs} = 0V, I_{D} = 1mA$	100		V
V _{GS(th)}	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 3mA$	2.0		4.5 V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200 nA
I _{DSS}	$V_{\text{DS}} = V_{\text{DSS}}, V_{\text{GS}} = 0V$ $T_{\text{J}} = 125^{\circ}\text{C}$			10 μΑ 250 μΑ
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 100A, Note 1$			11 mΩ

IXTN200N10L2

Symbol $(T_J = 25^\circ)$	Test Conditions C, Unless Otherwise Specified)	Characteristic Values Min. Typ. Max.				
9 _{fs}	$V_{_{DS}}$ = 10V, I $_{_{D}}$ = 60A, Note 1	55	73	90 S		
C _{iss}			23	nF		
C _{oss} C _{rss}	$\begin{cases} V_{gS} = 0V, V_{DS} = 25V, f = 1MHz \end{cases}$		3200 610	pF pF		
t _{d(on)}	Resistive Switching Times		40	ns		
ţ •	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 100A$		225	ns		
t _{d(off)} t _f	$\int R_{g} = 1\Omega$ (External)		127 27	ns ns		
Q _{g(on)})		540	nC		
\mathbf{Q}_{gs}	$V_{gs} = 10V, V_{Ds} = 0.5 \cdot V_{Dss}, I_{D} = 100A$		115	nC		
\mathbf{Q}_{gd}	J		226	nC		
R _{thJC}				0.15 °C/W		
R _{thCS}			0.05	°C/W		



(M4 screws (4x) supplied)

SYM	INCH	ÆS	MILLIMETERS		
21M	MIN	MAX	MIN	MAX	
Α	1.240	1.255	31.50	31.88	
В	.307	.323	7.80	8.20	
С	.161	.169	4.09	4.29	
D	.161	.169	4.09	4.29	
E	.161	.169	4.09	4.29	
F	.587	.595	14.91	15.11	
G	1.186	1.193	30.12	30.30	
Н	1.496	1.505	38.00	38.23	
J	.460	.481	11.68	12.22	
K	.351	.378	8.92	9.60	
L	.030	.033	0.76	0.84	
M	.496	.506	12.60	12.85	
Ν	.990	1.001	25.15	25.42	
0	.078	.084	1.98	2.13	
Р	.195	.235	4.95	5.97	
Q	1.045	1.059	26.54	26.90	
R	.155	.174	3.94	4.42	
S	.186	.191	4.72	4.85	
Т	.968	.987	24.59	25.07	
U	002	.004	-0.05	0.1	

Safe-Operating-Area Specification

Symbol	TestConditions		teristic Va Typ.	alues Max.
SOA	$V_{_{DS}} = 100V, I_{_{D}} = 5A, T_{_{C}} = 75^{\circ}C$, tp = 5s	500		W

Source-Drain Diode

Symbol (T _J = 25°C, U	Test Conditions Inless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max	
I _s	$V_{gs} = 0V$			200	Α
I _{sm}	Repetitive, Pulse Width Limited by $T_{_{JM}}$			800	Α
V _{SD}	I _F = 100A, V _{GS} = 0V, Note 1			1.4	V
$\left. egin{array}{ccc} I_{rr} & & \\ I_{RM} & & \\ Q_{RM} & & \end{array} ight\}$	$I_{F} = 100A$, -di/dt = 100A/µs $V_{R} = 50V$, $V_{GS} = 0V$		245 24.4 3.0		ns A µC

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

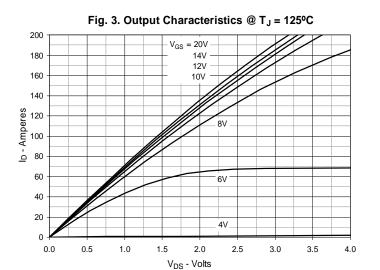
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

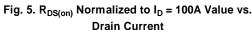
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:	4,850,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,404,065 B1 6,534,343	6,710,405 B2	6,759,692	7,005,734 B2 7,063,975 B2	7,157,338B2	
	4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537		





Fig. 1. Output Characteristics @ T_J = 25°C 200 $V_{GS} = 20V$ 180 14V 12V 160 10V 140 8V 4 Honeres 120 Amberes 7V . 80 60 6V 40 20 4V 0 0.2 1.2 1.4 0.0 0.4 0.6 0.8 1.0 1.6 1.8 2.0 V_{DS} - Volts





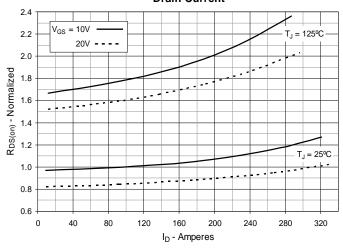


Fig. 2. Extended Output Characteristics @ T_J = 25°C

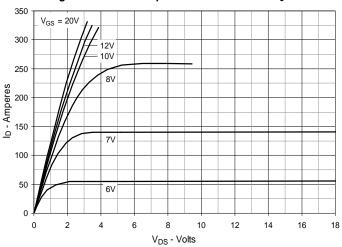


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 100A$ Value vs. Junction Temperature

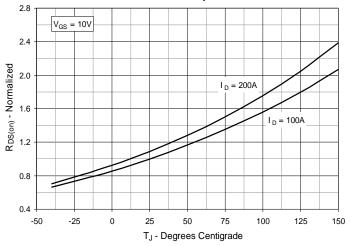
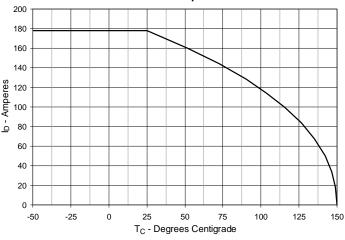


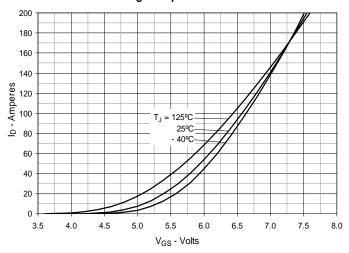
Fig. 6. Maximum Drain Current vs. Case Temperature



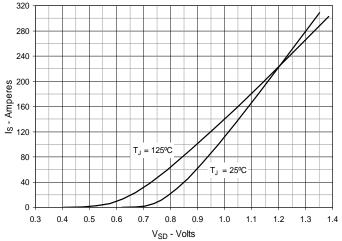


IXTN200N10L2

Fig. 7. Input Admittance









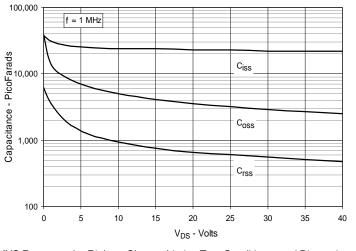


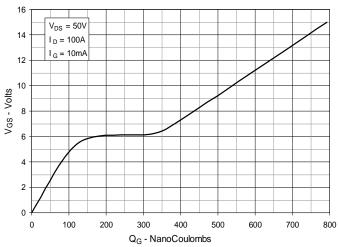
Fig. 8. Transconductance 140 T_J = - 40°C 120 25°C 100 125ºC 80 60 40 20 0

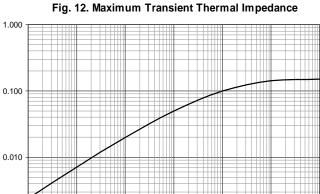


180

200 220

Fig. 10. Gate Charge





0.01

Pulse Width - Seconds

0.1

1

10

Z(th)JC - °C / W

0.001

0.00001

0.0001

0.001

g f s - Siemens

20

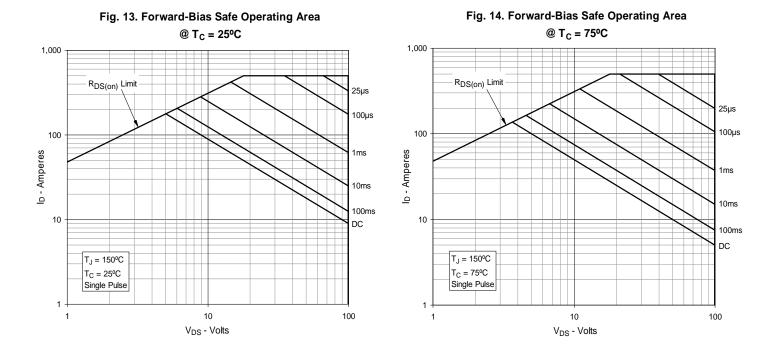
0

40

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



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IXYS REF: